

## Patent Assignment Abstract of Title

**Total Assignments: 1****Application #:** 09910447 **Filing Dt:** 07/19/2001**Patent #:** NONE**Issue Dt:****PCT #:** NONE**Publication #:** 20020072184 **Pub Dt:** 06/13/2002**Inventor:** Toshihiko Higuchi**Title:** Semiconductor device and method for manufacturing the same**Assignment: 1**

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**Conveyance:** ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).**Assignor:** HIGUCHI, TOSHIHIKO**Exec Dt:** 11/20/2001**Assignee:** SEIKO EPSON CORPORATION4-1, NISHI-SHINJUKU, 2-CHOME  
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